

SOT-23 Plastic-Encapsulate Diodes

CESD5V0AP Uni-direction ESD Protection Diode

DESCRIPTION

Designed to protect voltage sensitive electronic components from ESD and other transients. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD.

The combination of small size, high level of ESD protection makes them a flexible solution for applications such as HDMI, Display Port TM, and MDDI interfaces. It is designed to replace multiplayer varistors (MLV) in consumer equipments applications such as mobile phone, notebook, PAD, STB, LCD TV etc.

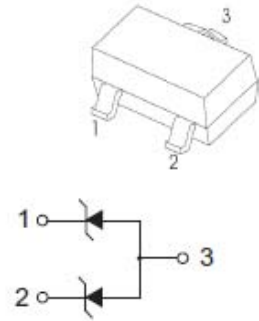
FEATURES

- Uni-directional ESD protection of two lines
- Reverse stand-off voltage: 5V
- Low reverse clamping voltage
- Low leakage current
- Excellent package: 2.90mm × 1.30mm × 1.00mm
- Fast response time
- JESD22-A114-B ESD Rating of class 3B per human body model
- IEC 61000-4-2 Level 4 ESD protection

APPLICATIONS

- Computers and peripherals
- Audio and video equipment
- Cellular handsets and accessories
- Portable electronics
- Other electronics equipments communication systems

SOT-23



MAXIMUM RATINGS ($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
IEC 61000-4-2 ESD Voltage	$V_{\text{ESD}}^{(1)}$	± 25	kV
Air Model			
Contact Model		± 25	
JESD22-A114-B ESD Voltage		± 16	
ESD Voltage	Machine Model	± 0.4	
Peak Pulse Power	$P_{\text{PP}}^{(2)}$	170	W
Peak Pulse Current	$I_{\text{PP}}^{(2)}$	13	A
Lead Solder Temperature – Maximum (10 Second Duration)	T_L	260	$^{\circ}\text{C}$
Junction Temperature	T_j	150	$^{\circ}\text{C}$
Storage Temperature Range	T_{stg}	-55 ~ +150	$^{\circ}\text{C}$

(1).Device stressed with ten non-repetitive ESD pulses.

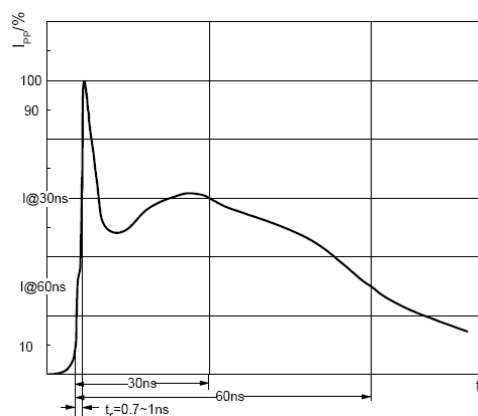
(2).Non-repetitive current pulse 8/20 μs exponential decay waveform according to IEC61000-4-5.

ESD standards compliance
IEC61000-4-2 Standard

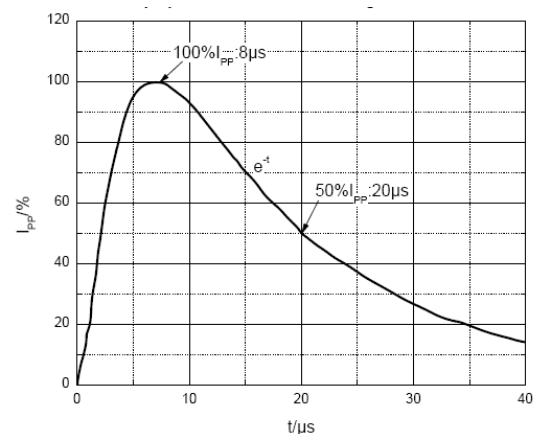
Contact Discharge		Air Discharge	
Level	Test Voltage kV	Level	Test Voltage kV
1	2	1	2
2	4	2	4
3	6	3	8
4	8	4	15

JESD22-A114-B Standard

ESD Class	Human Body Discharge V
0	0~249
1A	250~499
1B	500~999
1C	1000~1999
2	2000~3999
3A	4000~7999
3B	8000~15999



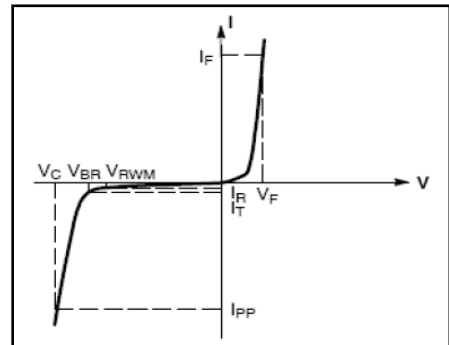
ESD pulse waveform according to IEC61000-4-2



8/20 μs pulse waveform according to IEC 61000-4-5

ELECTRICAL PARAMETER

Symbol	Parameter
V_C	Clamping Voltage @ I_{PP}
I_{PP}	Peak Pulse Current
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current
I_R	Reverse Leakage Current @ V_{RWM}
V_{RWM}	Reverse Standoff Voltage
V_F	Forward Voltage @ I_F
I_F	Forward Current



V-I characteristics for a uni-directional TVS

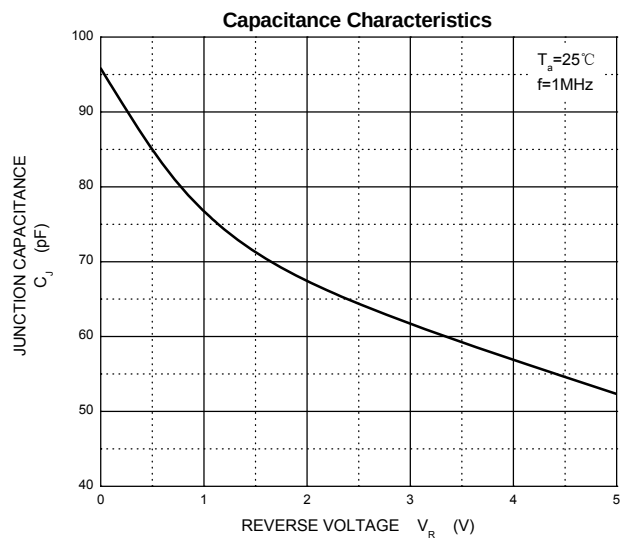
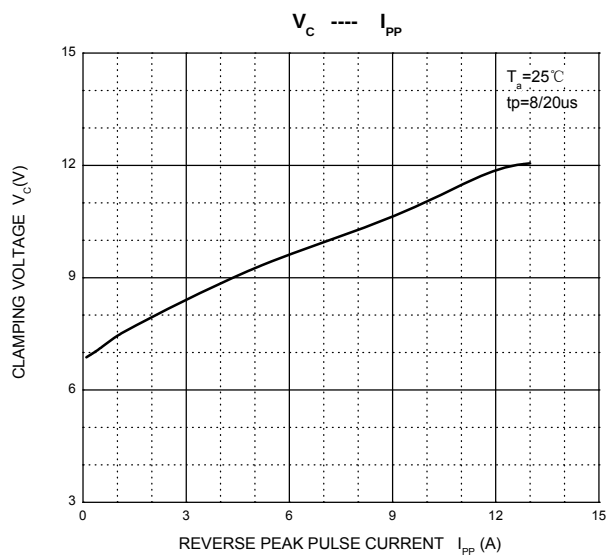
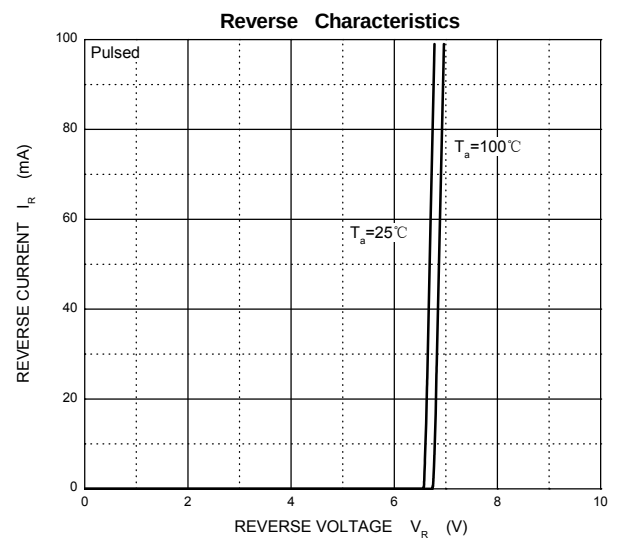
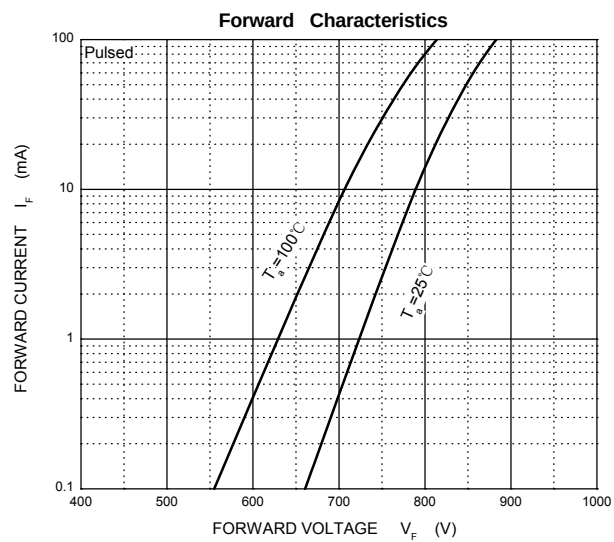
ELECTRICAL CHARACTERISTICS ($T_a=25^\circ\text{C}$ unless otherwise specified)

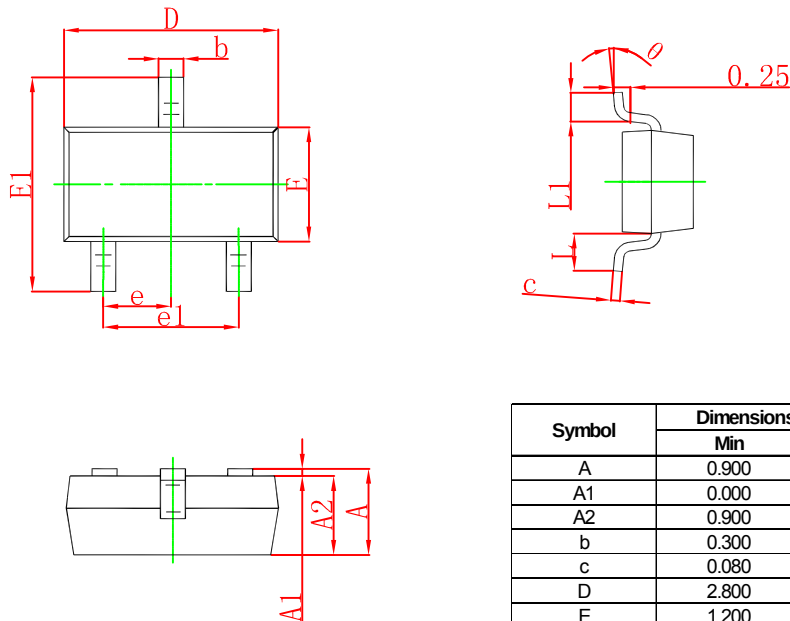
Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Reverse stand off voltage	$V_{RWM}^{(1)}$				5	V
Reverse leakage current	I_R	$V_{RWM}=5V$			10	μA
Breakdown voltage	$V_{(BR)}$	$I_T=1\text{mA}$	6.2		7.3	V
Clamping voltage	$V_C^{(2)}$	$I_{PP}=13A$			13	V
Forward voltage	V_F	$I_F=10\text{mA}$			0.9	V
Junction capacitance	C_J	$V_R=0V, f=1\text{MHz}$		95		pF

(1). Other voltages available upon request.

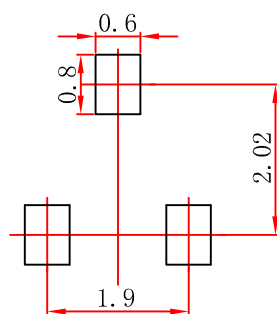
 (2). Non-repetitive current pulse 8/20 μs exponential decay waveform according to IEC61000-4-5

TYPICAL CHARACTERISTICS



PACKAGE OUTLINE AND PAD LAYOUT INFORMATION
SOT-23 Package Outline Dimensions


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout


Note:
 1. Controlling dimension: in millimeters.
 2. General tolerance: ± 0.05 mm.
 3. The pad layout is for reference purposes only.